

Proceeding

# Evaluation of Silicon Nanonet Field Effect Transistor as Photodiodes<sup>†</sup>

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**Abstract:** Silicon nanowire networks (nanonets) is an emerging candidate technology for sensor applications. In this work, we characterized Field Effect Transistor (FETs) employing silicon nanonet channels and evaluated their performance as photodiodes. We found that shorter and higher density nanonet channels have lower resistance and higher current flow. The drain current of the FETs doubled when irradiated with a continuous wave He-Ne laser (wavelength 632 nm). Finally, we examined the long-term stability of the FETs. The channel resistance increased by one order-of-magnitude after 6 months of storage in open air.

**Keywords:** silicon nanowires; nanonets; field effect transistors; characterization

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## 1. Introduction

Silicon nanowires (SiNWs) are one of the most widely studied nanostructures [1] deployed into many applications, such as biosensors [2], solar cells [3] and batteries [4]. In addition to interesting electrical and mechanical properties, they also have a high aspect ratio which makes them suitable for sensor applications. However, fabricating SiNWs with repeatable characteristics has proven challenging [5].

It was found that a more affordable and less complex approach is to produce networks of randomly distributed SiNWs, dubbed “nanonets” [6], with repeatable characteristics. These nanonets have, on average, similar mechanical, chemical and electronic properties. Recent years have seen increasing interest in nanonets. While interests has focused on carbon [6] and metallic nanonets [7], silicon nanonets have been recently fabricated and proposed as biosensor applications [8].

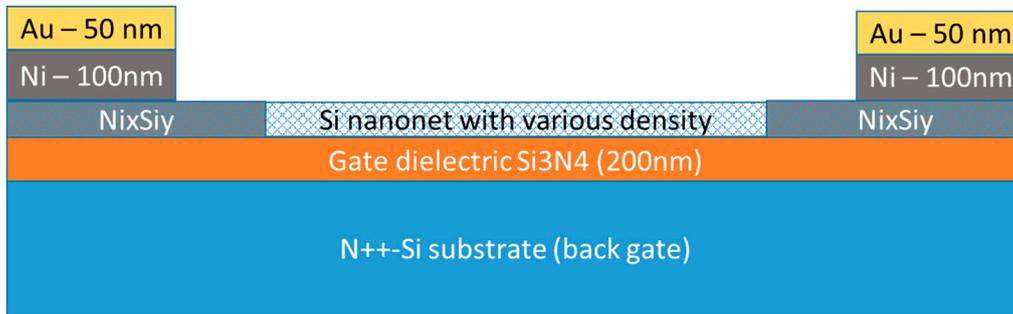
In this work; we characterize silicon nanonet-based field effect transistors (FETs) and explore their use as photodiodes. First, we compare the channel resistance among nanonet FETs with three different densities: Low ( $5.9 \times 10^7$  SiNWs/cm<sup>2</sup>), medium ( $8.2 \times 10^7$  SiNWs/cm<sup>2</sup>), and high ( $10.4 \times 10^7$  SiNWs/cm<sup>2</sup>). Second, we compare channel resistance for nanonet channel gaps of 5µm, 15µm and 30µm. Third, we evaluate the nanonet FETs performance as photodiodes. Finally, we examine the long-term stability of the nanonet FETs.

## 2. Methods

### 2.1. FET Fabrication

Silicon nanowires, average diameter 40 nm and length 7  $\mu\text{m}$ , were synthesized as detailed previously [8,9]. After growth, SiNWs were dispersed by sonication into deionized water for 5 min. Three different volumes of this suspension (24mL, 34mL and 46mL) were vacuum-filtered through a nitrocellulose membrane forming nanonets with density of  $5.9 \times 10^7$ ,  $8.2 \times 10^7$  and  $10.4 \times 10^7$  NWs/cm<sup>2</sup>, respectively. To fabricate the transistors, the nanonets were transferred onto 200 nm-thick Si<sub>3</sub>N<sub>4</sub> layer on top of a heavily doped silicon substrate by filter dissolution. Figure 1 displays a schematic of the fabricated device. SEM images were used to verify the homogeneity of the nanonet on the Si/Si<sub>3</sub>N<sub>4</sub> substrate, thereby ensuring successful transfer.

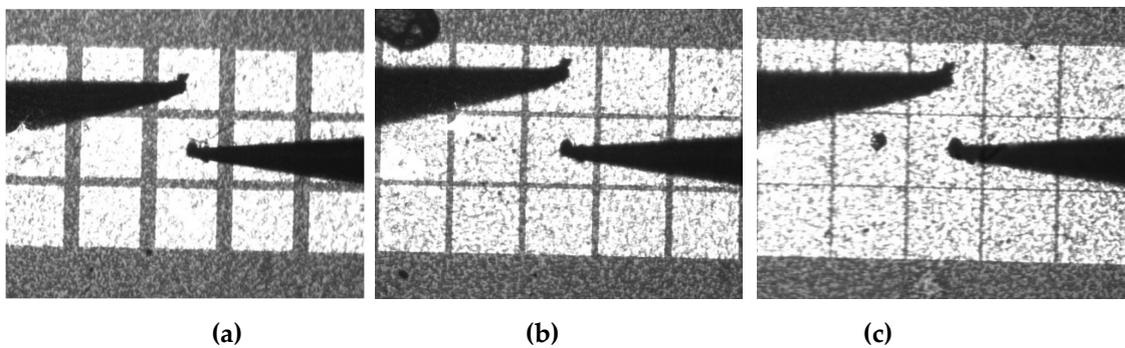
After the transfer, the nanonet conductivity is enhanced through sintering to create conducting paths at NW/NW junctions [9]. With this aim, rapid thermal annealing was carried out on the nanonets under nitrogen at 400°C for 1 min. The source and drain contacts are defined by photolithography and lift-off of a stack consisting of 100-nm-thick nickel and 50-nm-thick gold. Good contact between the semiconductor and electrodes is achieved through the silicidation performed at 400 °C for 1 minute.



**Figure 1.** Cross-Section of Si Nanonet FET

### 2.2. FET Characterization

In order to compare the channel resistance of the silicon nanonet FETs, their I-V curves were obtained using two Keithley 2400 SMUs. One SMU was used to supply gate voltage. Another SMU equipped with tungsten tips supplied the drain voltage and measured the drain current. The source was grounded. A laptop controlled and synchronized the two SMUs through serial ports and recorded their measurements. The gate voltage was swept up and down in the range  $V_{gs} = -25$ –25 V in steps of 1V, while the drain voltage remained constant.



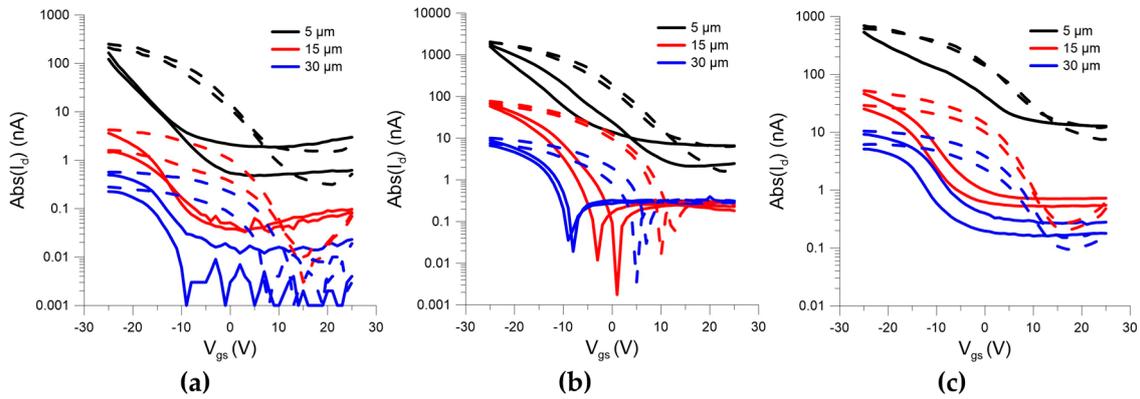
**Figure 2.** Pictures of (a) 30 $\mu\text{m}$ , (b) 15 $\mu\text{m}$ , and (c) 5 $\mu\text{m}$  channel gap Si nanonet FETs

### 3. Results and Discussion

#### 3.1. Characterization of the Si Nanonet FETs

We plot the drain current-gate voltage curves for low, medium and high-density Si nanonet FETs in Figure 3 at a drain voltage of  $V_{ds} = -4$  V. Each subfigure shows the curves for two consecutive gate voltage up-down sweeps for FETs with  $5\mu\text{m}$ ,  $15\mu\text{m}$  and  $30\mu\text{m}$  channel, where channel gap is defined as the distance between source and drain contacts. Up sweeps are shown in solid lines and down sweeps are shown in dashed lines. Comparing the three subfigures, we found that the drain current for high density nanonet FETs ( $10.4 \times 10^7$  SiNWs/cm<sup>2</sup>) is similar to that for medium density nanonet FETs ( $8.2 \times 10^7$  SiNWs/cm<sup>2</sup>) and that both are significantly higher than that for low density nanonet FETs ( $5.9 \times 10^7$  SiNWs/cm<sup>2</sup>). We conclude that higher density nanonets have lower channel resistance than low density nanonets due to the formation of more conducting paths linking the source and the drain.

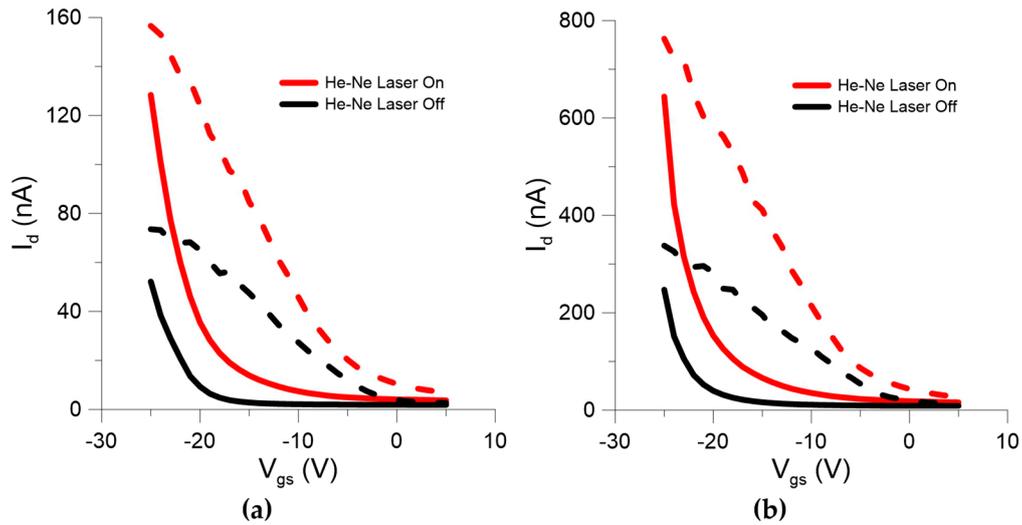
Irrespective of the channel density, we found that the drain current for the  $30\mu\text{m}$  channel nanonet FETs was lower than the drain current for the  $15\mu\text{m}$  channel nanonet FETs, which in turn is lower than the drain current for  $5\mu\text{m}$  channel nanonet FETs. In fact, the drain current for the low density  $30\mu\text{m}$  channel nanonet FETs was below the noise floor for gate voltages higher than  $V_{ds} = -10$  V. This indicates that FETs with shorter gaps have lower channel resistance than those with longer gaps. The variability in the nanonet FETs characteristics under consecutive voltage sweeps indicates the presence of hysteretic effects in the channel conductance. This hysteresis is considerable extending over several volts. This phenomenon is characteristic of a trapping-detrapping mechanism that takes place at the interface between the native oxide and the NW surface. By taking into account the sweep rate,  $1\text{V/s}$ , we can deduce that these traps interact slowly with the interface.



**Figure 3.** The  $I_d$ - $V_{gs}$  curves for (a) low density, (b) medium density and (c) high density Si nanonet FETs under gate voltage up (solid lines) and down (dashed lines) sweeps and a drain voltage of  $V_{ds} = -4$  V.

#### 3.2. Evaluation of the Si nanonet FETs as photodiodes

We used a continuous wave He-Ne laser (power  $< 1\text{mW}$ , wavelength  $632\text{nm}$ ) to irradiate the high density,  $5\mu\text{m}$  long nanonet channel FETs and measured the drain current while the gate voltage was swept up and down. In Figure 4, we compare the drain current-gate voltage curves when the laser was turned on and off at drain voltages of  $V_{ds} = 1$  V and  $V_{ds} = 5$  V. Up sweeps are shown in solid lines and down sweeps are shown in dashed lines. We found that laser irradiation almost doubled the drain current throughout the operation range. For example, during gate voltage up sweeps maximum drain current (at  $V_{gs} = -25$  V) increased from  $I_d = 52\text{nA}$  to  $128\text{nA}$  for  $V_{ds} = 1$  V and from  $I_d = 323\text{nA}$  to  $643\text{nA}$  for  $V_{ds} = 5$  V. Similarly, during gate voltage down sweeps drain current (at  $V_{gs} = -25$  V) increased from  $I_d = 73\text{nA}$  to  $156\text{nA}$  for  $V_{ds} = 1$  V and from  $I_d = 337\text{nA}$  to  $762\text{nA}$  for  $V_{ds} = 5$  V. The doubling in the drain voltage current allows us to conclude that Si nanonet FETs are viable candidates as photodiodes.

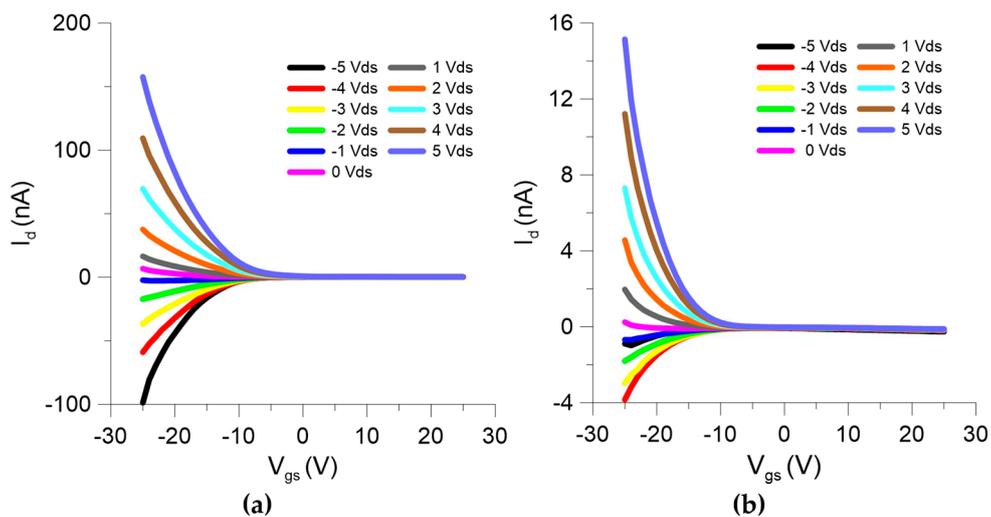


**Figure 4.** The  $I_d$ - $V_{gs}$  curves of the high density Si nanonet FETs when irradiation with He-Ne Laser was set on and off under gate voltage up (solid lines) and down (dashed lines) sweeps and a drain voltage of (a)  $V_{ds} = 1V$  and (b)  $V_{ds} = 5V$

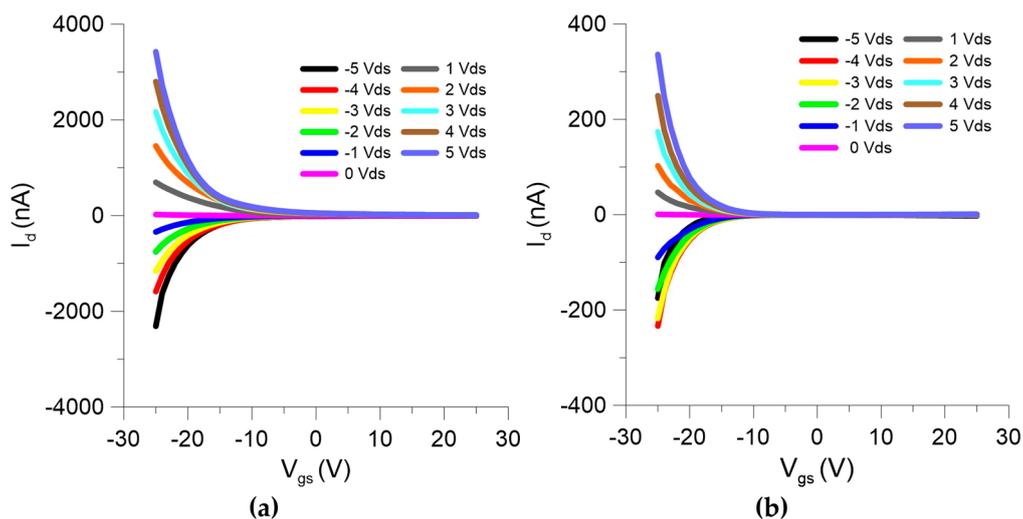
### 3.2. Long Term Stability of the Si Nanonet FETs

In pursuance of understanding the long-term stability of Si nanonet FETs, we measured the drain current-gate voltage curves for medium density  $5\mu m$  and  $15\mu m$  nanonet channel FETs in March 2017 and the same curves for those FETs in September 2017, after 6 months of storage in open air. The  $I_d$ - $V_{gs}$  curves before and after aging are compared in Figure 5 for medium density nanonet FETs and in Figure 6 for high density nanonet FETs under gate voltage up sweeps. First, we note that increasing drain voltage increases the drain current as expected. The results also show one order-of-magnitude drop in drain current for both medium and high density nanonet FETs.

Since the nanonets were treated to prevent NW-NW junction oxidation [9], such a decrease in conductance is not due to appearance of a barrier at the junctions. As a consequence, we surmise that the sweep-on-sweep variability in conductance, observed above, and the degradation in conductance over time, observed here, are due to charge trapping in the nanonet channels and at NW/oxide interface as well as interaction with environment since the FETs behavior is highly sensitive to surface modification.



**Figure 5.** The up-sweep  $I_d$ - $V_{gs}$  curves for medium density  $15\mu m$  nanonet channel FETs measured in (a) March and (b) September 2017



**Figure 6.** The up-sweep  $I_d$ - $V_{gs}$  curves for medium density  $5\mu\text{m}$  nanonet channel FETs measured in (a) March and (b) September 2017

### 3. Conclusion

We characterized the channel resistance of Si nanonet FETs with varying nanonet densities and channel gaps and found that shorter and higher density channels have lower resistance and higher currents. We also evaluated Si nanonet FETs potential for use as photodiodes by measuring the drain current while continuous wave He-Ne laser (wavelength of 632 nm) irradiation was turned on and off. The drain current almost doubled due to laser irradiation irrespective of the drain and gate voltages. Although further work is required to optimize the FETs performances and their sensitivity to light, the present results indicate that they are good candidates for miniaturized photodiodes. Finally, we examined the long-term stability of silicon nanonet FETs and found that channel resistance increased by an order-of-magnitude after six months of storage in open air. Further work is required to examine the underlying causes of charge trapping in the channels and increase in their resistance overtime and to devise methods to overcome these challenges.

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**Author Contributions:** C. T., M. L. and B. S. fabricated the Si nanonet FETs. S. P and M. I. designed the experiments, while M. K. and S. P. carried them out. M. K. wrote the initial draft of the manuscript and E. A., C. T. and M. L. revised it. C. T., E. A. and M. Y. supervised the research effort and reviewed the final manuscript.

**Conflicts of Interest:** The authors declare no conflict of interest.

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